

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3171976

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shih-Chieh Pu	12/30/2014
Ming-Tsung Lee	12/30/2014
Cheng-Hua Yang	12/30/2014
Nien-Chung Li	12/30/2014
Wen-Fang Lee	12/30/2014
Chih-Chung Wang	12/30/2014
RECEIVING PARTY DATA	
Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu City
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14590957
CORRESPONDENCE DATA	
Fax Number:	(703)997-4517
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3027291562
Email:	Patent.admin.uspto.cr@naipo.com
Correspondent Name:	WINSTON HSU
Address Line 1:	P.O.BOX 506
Address Line 4:	MERRIFIELD, VIRGINIA 22116
ATTORNEY DOCKET NUMBER:	NAUP2369USA
NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	01/06/2015
Total Attachments: 12 source=2147365#page1.tif	

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**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

Title of Invention:

HIGH VOLTAGE METAL-OXIDE-SEMICONDUCTOR TRANSISTOR DEVICE

As the below named inventor, I hereby declare that:
This declaration is directed to:

☒ The attached application, or

☐ United States application number _____ filed on _____, or

☐ PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the payment by **UNITED MICROELECTRONICS** having a postal address of **CORP.**

No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

(referred to as "ASSIGNEE" below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal this DEC 30 2014 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No NAUP2369USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Shih-Chieh Pu**

Date: **DEC 30 2014**

Signature: Shih-Chieh Pu

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Docket No NAUP2369USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Ming-Tsung Lee**

Date: **DEC 30 2014**

Signature: Ming-Tsung Lee

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LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Cheng-Hua Yang**

Date: **DEC 30 2014**

Signature:

Cheng-Hua Yang

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Docket No NAUP2369USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Nien-Chung Li**

Date: **DEC 30 2014**

Signature: Nien Chung Li

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Docket No NAUP2369USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Wen-Fang Lee**

Date: **DEC 30 2014**

Signature:

Wen - Fang Lee

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Docket No NAUP2369USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Chih-Chung Wang**

Date: **DEC 30 2014**

Signature: Chih-Chung Wang

NPO#NAU-P2369-USA:0
CUST#UMCD-2014-0411

Page 12 of 12

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RECORDED: 01/06/2015

PATENT
REEL: 034648 FRAME: 0426